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FAIRCHILD

FDC2612 200V N-Channel PowerTrench[®] MOSFET

General Description

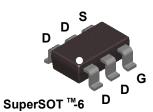
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

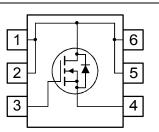
Applications

DC/DC converter

Features

- 1.1 A, 200 V. $R_{DS(ON)}$ = 725 m Ω @ V_{GS} = 10 V
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability
- Fast switching speed
- Low gate charge (8nC typical)





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol		Parameter		Ratings	Units
V _{DSS}	Drain-Source	e Voltage		200	V
V _{GSS}	Gate-Sourc	e Voltage		± 20	V
ID	Drain Current – Continuous (Note 1a)			1.1	
	– Pulsed			4	
PD	Maximum Power Dissipation (Note 1a)		(Note 1a)	1.6	W
			(Note 1b)	0.8	
			()	010	
		nd Storage Junction T	· · ·	-55 to +150	°C
Therma	al Charac	Ū	emperature Range		°C °C/W
T _J , T _{STG} Therma R _{0JA} R _{0JC}	al Charac Thermal Re	teristics	emperature Range	-55 to +150	
Therma _{Rөја} Rөјс Packag	al Charac Thermal Re Thermal Re	teristics	Ambient (Note 1a) Case (Note 1)	-55 to +150 78	°C/W

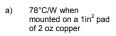
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FDC2612 Rev B3 (W)

FDC2612

Electrical Characteristics T _A = 25°C unless otherwise noted						1
Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Char	acteristics	·				
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	200			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		246		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 160 V, V _{GS} = 0 V			1	μA
I _{GSSF}	Gate–Body Leakage, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate–Body Leakage, Reverse	$V_{GS} = -20 \text{ V}$, $V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2	4	4.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-8.7		mV/°C
R _{DS(on)}	Static Drain–Source On Resistance			605 1133	725 1430	mΩ
I _{D(on)}	On–State Drain Current	V_{GS} = 10 V, V_{DS} = 10 V	4			A
g fs	Forward Transconductance	$V_{DS} = 10 V$, $I_D = 1.1 A$		4.4		S
Dynami	c Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 100 V$, $V_{GS} = 0 V$,		234		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		18		pF
C _{rss}	Reverse Transfer Capacitance			8		pF
Switchi	ng Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	V _{DD} = 100 V, I _D = 1 A,		6	12	ns
tr	Turn–On Rise Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		6	12	ns
t _{d(off)}	Turn–Off Delay Time			17	30	ns
t _f	Turn–Off Fall Time			8	16	ns
Qg	Total Gate Charge	V _{DS} = 100 V, I _D = 1.1 A,		8	11	nC
Q _{gs}	Gate–Source Charge	V _{GS} = 10 V		1.6		nC
Q_{gd}	Gate–Drain Charge			2.2		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Source				1.3	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_{S} = 1.3 A$ (Note 2)		0.8	1.2	V
rr	Diode Reverse Recovery Time	$I_{\rm F} = 1.1 {\rm A},$		74.5		nS
Q _{rr} lotes:	Diode Reverse Recovery Charge	$d_{iF}/d_t = 300 \text{ A}/\mu \text{s}$ (Note 2)		194		nC





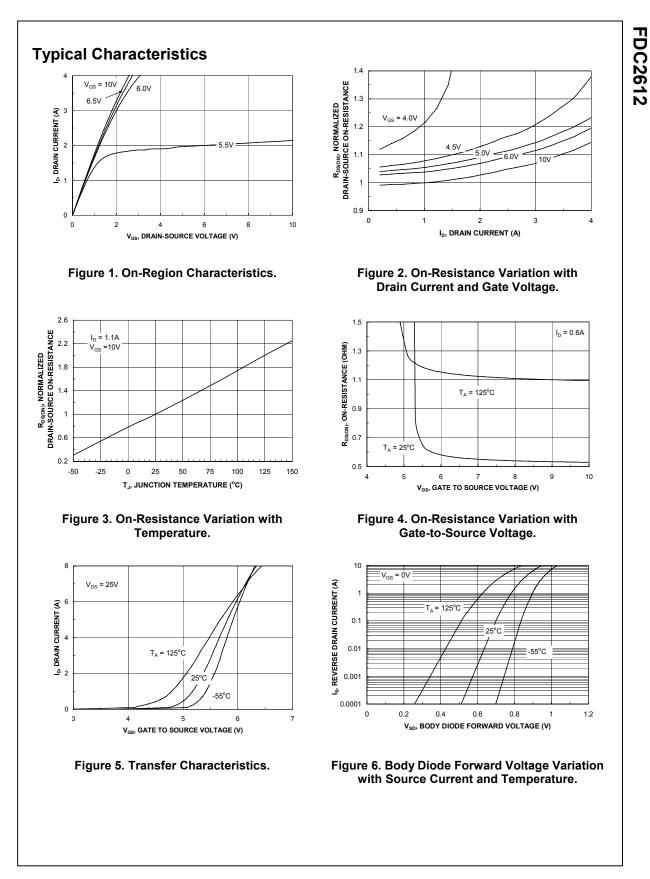


b) 156°C/W when mounted on a minimum pad of 2 oz copper

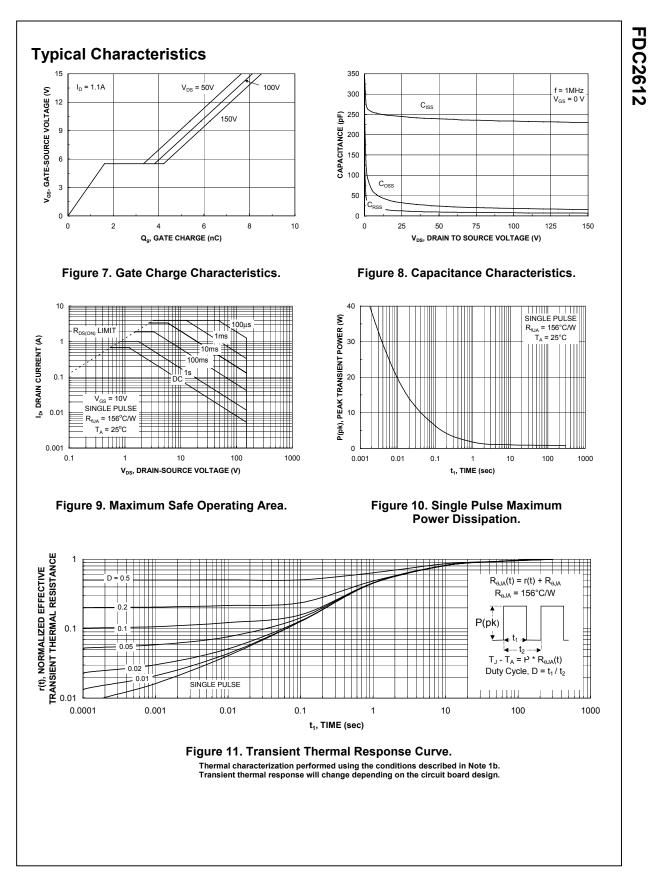
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

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		Rev. H4

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